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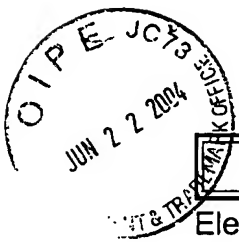
Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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Application ID: 10813945  
Title of Invention: High-Density connection  
between multiple circuit boards  
First Named Inventor: Douglas Wildes  
Domestic/Foreign Application: Domestic Application  
Filing Date: 2004-03-30  
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Statement  
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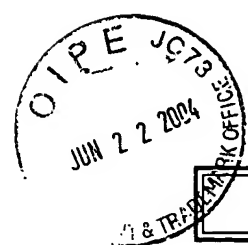
Total Fees Authorized:

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**TRANSMITTAL**

Electronic Version v1.1  
Stylesheet Version v1.1.0


<b>Title of Invention</b>	High-Density connection between multiple circuit boards									
<p>Application Number: 10/813945 </p> <p>Date: 2004-03-30</p> <p>First Named Applicant: Douglas Glenn</p> <p>Confirmation Number: 5777</p> <p>Attorney Docket Number: 134730</p>										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Dennis M Flaherty Registered Number: 31159</td><td>/dennis flaherty/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Dennis M Flaherty Registered Number: 31159	/dennis flaherty/	Attorney		
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Comments										



## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

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<p>Application Number: 10/813945 </p> <p>Confirmation Number: 5777</p> <p>First Named Applicant: Douglas Wildes</p> <p>Attorney Docket Number: 134730</p> <p>Search string: ( 6520789 or 6437557 or 6309223 or 6162065 or 5871362 or 5378161 ).pn.</p> <p><b>US Patent Documents</b></p> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>6520789</td><td>2003-02-18</td><td>Daughert, Jr. et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>6437557</td><td>2002-08-20</td><td>Smith</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>6309223</td><td>2001-10-30</td><td>Wolfe</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>6162065</td><td>2000-12-19</td><td>Benham</td><td></td><td></td><td></td></tr><tr><td></td><td>5</td><td>5871362</td><td>1999-02-16</td><td>Campbell et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>6</td><td>5378161</td><td>1995-01-03</td><td>Loder</td><td></td><td></td><td></td></tr></tbody></table> <p><b>Signature</b></p> <table border="1"><tr><td><b>Examiner Name</b></td><td><b>Date</b></td></tr><tr><td></td><td></td></tr></table>		init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	6520789	2003-02-18	Daughert, Jr. et al.					2	6437557	2002-08-20	Smith					3	6309223	2001-10-30	Wolfe					4	6162065	2000-12-19	Benham					5	5871362	1999-02-16	Campbell et al.					6	5378161	1995-01-03	Loder				<b>Examiner Name</b>	<b>Date</b>		
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